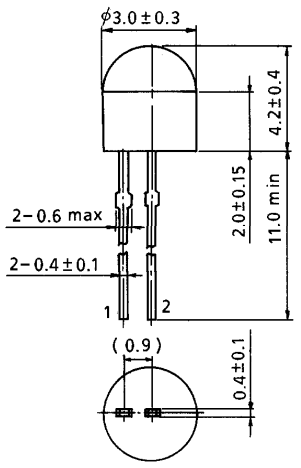
TOSHIBA INFRARED LED GaAℓAs INFRARED EMITTER

TLN203

INFRARED LED FOR PHOTOSENSORS

Unit : mm



( ) : Reference value

TOSHIBA 4-3G1

Weight : 0.09 g (typ.)

OPTO-ELECTRONIC SWITCHES

TAPE AND CARD READERS

ROTARY ENCODERS

FDD (FLOPPY DISK DRIVE) DETECTION

- High radiant intensity
- Ideal for use in combination with TPS613 phototransistor

PIN CONNECTION

1. Cathode
2. Anode

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current	I_F	50	mA
Forward Current Derating (Ta > 25°C)	ΔI_F	−0.67	mA / °C
Pulse Forward Current (Note)	I_{FP}	1	A
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	−20~75	°C
Storage Temperature	T_{stg}	−30~100	°C

(Note) : Pulse Width ≦ 100 μs, repetitive frequency = 100 Hz

OPTICAL AND ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	Min	Typ.	Max	UNIT
Forward Voltage	V_F	I_F = 50 mA	—	1.45	1.9	V
Reverse Current	I_R	V_R = 5 V	—	—	10	μA
Radiant Intensity	I_E	I_F = 20 mA	1.0	—	—	mW / sr
Radiant Power	P_O	I_F = 20 mA	—	3.5	—	mW
Capacitance	C_T	V_R = 0, f = 1 MHz	—	60	—	pF
Peak Emission Wavelength	λ_P	I_F = 20 mA	—	880	—	nm
Spectral Line Half Width	$\Delta\lambda_P$	I_F = 20 mA	—	80	—	nm
Half Value Angle	$\theta_{\frac{1}{2}}$	I_F = 20 mA	—	±35	—	°

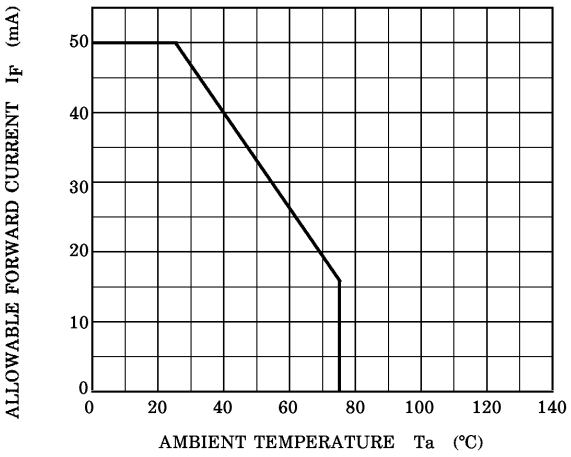
PRECAUTIONS

Please be careful of the followings.

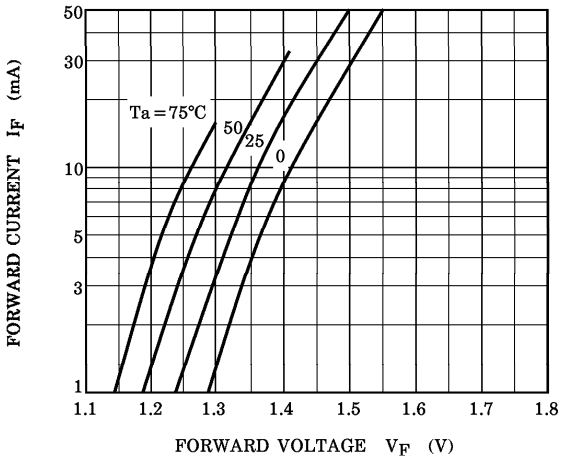
1. Soldering must be performed under the lead stopper.
2. Soldering temperature : 260°C max
   Soldering time : 3 s max
3. When forming the leads, bend each lead under the 2 mm from the body of the device.
   Soldering must be performed after the leads have been formed.
4. Radiation intensity falls over time due to the current which flows in the infrared LED.
   When designing a circuit, take into account this change in radiant power over time.
   The ratio of fluctuation in radiation intensity to fluctuation in optical output is 1 : 1.

$$\frac{I_E(t)}{I_E(0)} = \frac{P_O(t)}{P_O(0)}$$

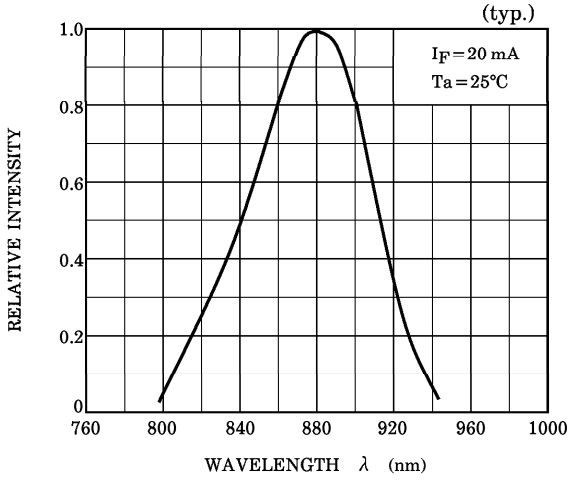
I_F – Ta



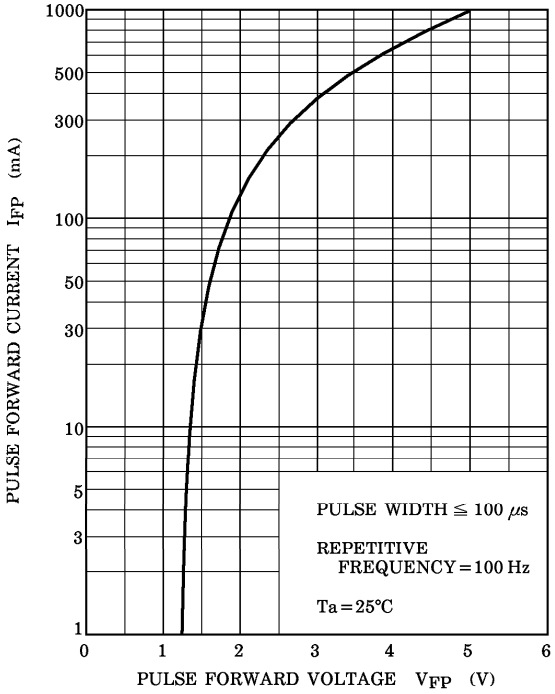
I_F – V_F (typ.)



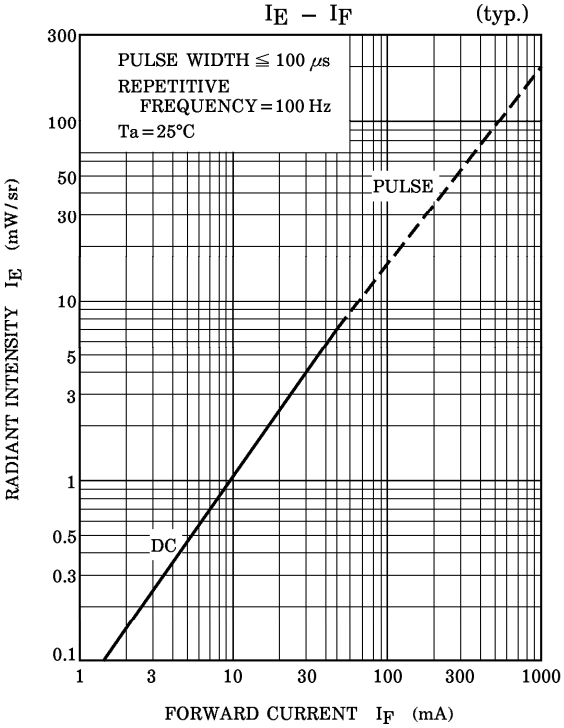
WAVELENGTH CHARACTERIISTIC (typ.)



I_{FP} – V_{FP} (typ.)

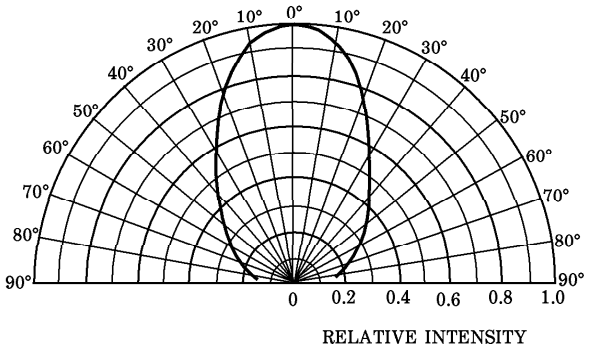


I_E – I_F (typ.)

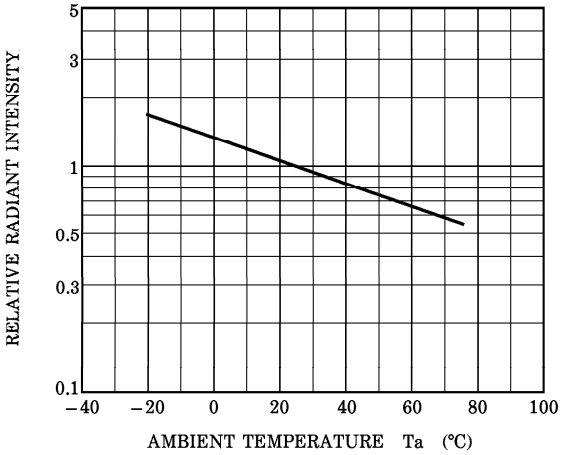


RADIATION PATTERN (typ.)

(Ta = 25°C)



RELATIVE I_E – Ta (typ.)



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